NO. 4519 P. 3

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

### **DECLARATION FOR PATENT APPLICATION**

RECEIVED : CENTRAL FAX CENTER

JUL 1 3 2008

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## BENZIMIDAZOLE DERIVATIVES: PREPARATION AND PHARMACEUTICAL APPLICATIONS

the specification of which was filed on March 21, 2006, which is a National Phase of PCT/SG2004/000307.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by an amendment, if any, specifically referred to herein.

I acknowledge the duty to disclose all information known to me that is material to patentability in accordance with Title 37, Code of Federal Regulations, § 1.56.

### FOREIGN PRIORITY CLAIM

I hereby claim foreign priority benefits under Title 35, United States Code § 119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

x	no such foreign applications have been filed
	such foreign application have been filed as follows:

## EARLIEST FOREIGN APPLICATION(S), IF ANY FILED WITHIN 12 MONTHS (6 MONTHS FOR DESIGN) PRIOR TO THIS U.S. APPLICATION

Application Number	Country	Date of Filing	Priority Claimed Under 35 USC 119

## ALL FOREIGN APPLICATION(S), IF ANY FILED MORE THAN 12 MONTHS (6 MONTHS FOR DESIGN) PRIOR TO THIS U.S. APPLICATION

Application Number	Country	Date of Filing
Application 1100000		

## CLAIM FOR BENEFIT OF EARLIER U.S. PROVISIONAL APPLICATIONS

Title 25 United States Code 8119(c), of any Uni	ited
I hereby claim priority benefits under Title 35, United States Code §119(e), of any Uni	
States provisional patent application(s) listed below:	

1	<u> </u>	no such U.S.	provisional	applications	have	been	filed
		no such U.S.	DIO APPIORE	uppmount-			

## x such U.S. provisional application have been filed as follows:

Date of Filing	Under 35 USC 119
September 22, 2003	X Yes No
December 22, 2003	X Yes No
	September 22, 2003

## CLAIM FOR BENEFIT OF EARLIER U.S./PCT APPLICATION(S)

I hereby claim the benefit under Title 35, United States Code, §120 of the United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose all information that is material to patentability in accordance with Title 37, Code of Federal Regulations, §1.56 which became available to me between the filing date of the prior application and the national or PCT international filing date of this application:

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x such U.S./PCT application have been filed as follows:

Application Number	Relationship	Parent Application	Date of Filing
PCT/SG2004/000307			21 September 2004

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint:

All practitioners at Customer Number 30678

all of Connolly Bove Lodge & Hutz LLP, 1990 M Street, N.W., Suite 800, Washington, DC 20036, jointly, and each of them severally, my attorneys at law/patent agent(s), with full power of substitution, delegation and revocation, to prosecute this application, to make alterations and amendments therein, to receive the patent, and to transact all business in the U. S. Patent and Trademark Office connected therewith.

The undersigned hereby authorizes the U.S. attorney or agent named herein to accept and follow instructions from S\*BIO Pte Ltd. as to any action to be taken in the United States Patent and Trademark Office regarding this application without direct communication between the U.S. attorney or agent and the undersigned. In the event of a change in the persons from whom instructions may be taken, the U.S. attorney or agent named herein will be so notified by the undersigned.

Please mail all correspondence to Mark J. Pino, whose address is:

Connolly Bove Lodge & Hutz LLP 1990 M Street, N.W., Suite 800 Washington, DC 20036

Please direct telephone calls to: Mark J. Pino at (202) 331-7111.

Please direct facsimiles to: Mark J. Pino at (202) 293-6229.

Dizhong Chen Sole or first inventor's signature  Apr. 21, 2006  Residence Singapore, Singapore Citizenship People's Republic of China Mailing Address Block 212, #11-126 Chua Chu Kang Central Singapore 680212 SINGAPORE Full name of second inventor, if any Weiping Deng Second inventor's signature  Date  Residence Shanghai, China Citizenship People's Republic of China Mailing Address Apt #75, Rm 34 Dongan Erchun Zhongshan Road No 2 (South) Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag Third inventor's signature  Mailing Address Singapore, Singapore Citizenship Thailand  Mailing Address 30 Dover Rise, Dover Parkview Tower D. #16-03		
Residence Singapore, Singapore Citizenship People's Republic of China Mailing Address Block 212, #11-126 Chua Chu Kang Central Singapore 680212 SINGAPORE  Full name of second inventor, if any Weiping Deng Second inventor's signature  Residence Shanghai, China Citizenship People's Republic of China Mailing Address Apt #75, Rm 34 Dongan Erchun Dongan Erchun Dongan Erchun Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag Third inventor's signature  Date  Da	ull name of sole or first inventor	
Residence Singapore, Singapore Citizenship People's Republic of China Mailing Address Block 212, #11-126 Chua Chu Kang Central Singapore 680212 SINGAPORE Full name of second inventor, if any Weiping Deng Second inventor's signature  Date  Date  Residence Shanghai, China Citizenship People's Republic of China Mailing Address Apt #75, Rm 34 Dongan Erchun Zhongshan Road No 2 (South) Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag Third inventor's signature  Lither Mailing Address July 106  Residence Singapore, Singapore Chizenship Thailand  Mailing Address 30 Dover Rise, Dover Parkview Tower D, #16-03	Dizhong Chen	Date
Residence Singapore, Singapore Citizenship People's Republic of China Mailing Address Block 212, #11-126 Chua Chu Kang Central Singapore 680212 SINGAPORE  Full name of second inventor, if any Weiping Deng Second inventor's signature  Residence Shanghai, China Citizenship People's Republic of China Mailing Address Apt #75, Rm 34 Dongan Erchum Zhongshan Road No 2 (South) Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag Third inventor's signature  Citizenship Date  Citizenship Date  Citizenship Thailand  Mailing Address 30 Dover Rise, Dover Parkview Tower D, #16-03		Anr. 21, 200 K
Singapore, Singapore  Citizenship People's Republic of China  Mailing Address Block 212, #11-126 Chua Chu Kang Central Singapore 680212 SINGAPORE  Full name of second inventor, if any Weiping Deng Second inventor's signature  Residence Shanghai, China Citizenship People's Republic of China  Mailing Address Apt #75, Rm 34 Dongan Erchum Zhongshan Road No 2 (South) Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag Third inventor's signature  Length Leng	(Def)	7-17-17-0
Singapore, Singapore  Citizenship People's Republic of China  Mailing Address Block 212, #11-126 Chua Chu Kang Central Singapore 680212 SINGAPORE  Full name of second inventor, if any Weiping Deng Second inventor's signature  Residence Shanghai, China Citizenship People's Republic of China  Mailing Address Apt #75, Rm 34 Dongan Erchum Zhongshan Road No 2 (South) Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag Third inventor's signature  Length Leng		_
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Mailing Address Block 212, #11-126 Chua Chu Kang Central Singapore 680212 SINGAPORE  Full name of second inventor, if any Weiping Deng Second inventor's signature  Residence Shanghai, China  Citizenship People's Republic of China  Mailing Address Apt #75, Rm 34 Dongan Erchun Zhongshan Road No 2 (South) Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag Third inventor's signature  Mailing Address  Third inventor's signature  Mailing Address  Third inventor's signature  Mailing Address  Third inventor's signature  Third inventory sign	Citizenship People's Republic of China	
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Singapore 680212 SINGAPORE  Full name of second inventor, if any Weiping Deng Second inventor's signature  Residence Shanghai, China Crizenship People's Republic of China Mailing Address Apt #75, Rm 34 Dongan Erchum Zhongshan Road No 2 (South) Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag Third, inventor's signature  Chizenship Thailand Mailing Address 30 Dover Rise, Dover Parkview Tower D, #16-03	Block 212, #11-126	
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Weiping Deng Second inventor's signature  Residence Shanghai, China Citizenship People's Republic of China Mailing Address Apt #75, Rm 34 Dongan Erchun Zhongshan Road No 2 (South) Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag Third inventor's signature  White January China Residence Singapore, Singapore Citizenship Thailand Mailing Address 30 Dover Rise, Dover Parkview Tower D, #16-03	I	
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Shanghai, China  Citizenship People's Republic of China  Mailing Address Apt #75, Rm 34 Dongan Erchun Zhongshan Road No 2 (South) Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag  Third inventor's signature  White Chizenship Thailand  Mailing Address 30 Dover Rise, Dover Parkview Tower D, #16-03	2444	
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Citizenship People's Republic of China  Mailing Address Apt #75, Rm 34 Dongan Erchun Zhongshan Road No 2 (South) Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag  Third inventor's signature  Citizenship Thailand  Mailing Address 30 Dover Rise, Dover Parkview Tower D, #16-03		
Mailing Address  Apt #75, Rm 34  Dongan Erchum  Zhongshan Road No 2 (South)  Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any  Kanda Sangthongpitag  Third inventor's signature    Date	Shanghai, China	
Apt #75, Rm 34 Dongan Erchun Zhongshan Road No 2 (South) Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag Third inventor's signature		
Dongan Erchum Zhongshan Road No 2 (South) Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag Third inventor's signature    Date		
Zhongshan Road No 2 (South) Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag  Third inventor's signature	Apt #75, Km 54	
Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA  Full name of third inventor, if any Kanda Sangthongpitag  Third inventor's signature    Date   17/4/06     Residence   Singapore     Citizenship   Thailand     Mailing Address     30 Dover Rise, Dover Parkview     Tower D, #16-03	Zhangshan Road No 2 (South)	•
Full name of third inventor, if any Kanda Sangthongpitag  Third inventor's signature    Date     Date	Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA	
Kanda Sangthongpitag  Third inventor's signature    Complement   Compl		
Residence Singapore, Singapore Citizenship Thailand Mailing Address 30 Dover Rise, Dover Parkview Tower D, #16-03		
Residence Singapore, Singapore Citizenship Thailand  Mailing Address 30 Dover Rise, Dover Parkview Tower D, #16-03	Kanda Sangthongpitag	Date
Residence Singapore, Singapore Citizenship Thailand  Mailing Address 30 Dover Rise, Dover Parkview Tower D, #16-03		22/11/06
Residence Singapore, Singapore Citizenship Thailand Mailing Address 30 Dover Rise, Dover Parkview Tower D, #16-03	Kan de Janestrand priez	2314100
Singapore, Singapore  Citizenship Thailand  Mailing Address 30 Dover Rise, Dover Parkview  Tower D, #16-03		
Citizenship Thailand  Mailing Address 30 Dover Rise, Dover Parkview  Tower D, #16-03		
Mailing Address 30 Dover Rise, Dover Parkview Tower D, #16-03		
30 Dover Rise, Dover Parkview Tower D, #16-03	Mailing Address	
Tower D, #16-03	30 Dover Rise, Dover Parkview	
Singapore 138686	Tower D, #16-03	
ON A PORE	Singapore 138686	
SINGAPORE	SINGAPORE	
Full name of fourth inventor, if any	Sail same of fruith inventor, if any	
Hong V Song		
Fourth inventor's signature	Fourth inventor's signature	Date
20104/06	/ ~	104/06
Residence		·
	Singapore, Singapore	
Singapore, Singapore		
Citizenship People's Republic of China	Mailing Address	
Citizenship People's Republic of China  Mailing Address	T 1 704 #10 201	
Citizenship People's Republic of China  Mailing Address  Block 706, #10-391	Block 706, #10-391	
Citizenship People's Republic of China  Mailing Address	Block 706, #10-391 Clementi West St 2	

Full name of fifth inventor, if any	•
Eric T. Sun	Date .
Fifth inventor's signature	
Epi T. Sun	21/04/2006
Residence	
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Citizenship US	
Mailing Address	
40 Coronation Road West #04-04 Astrid Meadows	
Singapore 269258	
SINGAPORE	
Full name of sixth inventor, if any	,
Niefang Yu	
Sixth inventor's signature	Date
11	Apr 21, 2006
Why with the	100161 21, 2006
Residence	•
Singapore, Singapore	
Citizenship People's Republic of China	
Mailing Address	
Blk 410 Woodlands St.41, #11-89	
Singapore 730410	
SINGAPORE	
Full name of seventh inventor, if any	
Yong Zou	
Seventh inventor's signature	Date
-	
Residence	
Beijing, China	
Citizenship People's Republic of China	
Mailing Address	
Room 1804, Building 5	
No. 28 North Xizhimen Street	
Beijing 100088 PEOPLE'S REPUBLIC OF CHINA	
I DOLDE OF TOTAL OF THE PARTY O	
Full name of eighth inventor, if any	
Eighth inventor's signature	Date
<del>-</del>	
Residence	
Citizenship	
Mailing Address	

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

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I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

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# EARLIEST FOREIGN APPLICATION(S), IF ANY FILED WITHIN 12 MONTHS (6 MONTHS FOR DESIGN) PRIOR TO THIS U.S. APPLICATION

			Priority Claimed Under 35 USC 119
Application Number	Conntry	Date of Filing	Under 35 USC 119
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# ALL FOREIGN APPLICATION(S), IF ANY FILED MORE THAN 12 MONTHS (6 MONTHS FOR DESIGN) PRIOR TO THIS U.S. APPLICATION

(0 1/1011112		Date of Filing
Application Number	Country	Date CITEME
Application	• — • · · · · · · · · · · · · · · · · ·	
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## CLAIM FOR BENEFIT OF EARLIER U.S. PROVISIONAL APPLICATIONS

I hereby claim priority benefits under Title 35, United States Code §119(e), of any United States provisional patent application(s) listed below:

cations have been f	filed.
C	cations have been t

x such U.S. provisional application have been filed as follows:

O.B. provided		Priority Claimed
Application Number	Date of Filing	Under 35 USC 119
60/504,214	September 22, 2003	X Yes No
	December 22, 2003	X Yes No
60/530,890		

## CLAIM FOR BENEFIT OF EARLIER U.S./PCT APPLICATION(S)

I hereby claim the benefit under Title 35, United States Code, §120 of the United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose all information that is material to patentability in accordance with Title 37, Code of Federal Regulations, §1.56 which became available to me between the filing date of the prior application and the national or PCT international filing date of this application:

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			1

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Please direct facsimiles to: Mark J. Pino at (202) 293-6229.

Full name of sole or first inventor	
Dizhong Chen	Date
Sole or first inventor's signature	
Residence	
Singapore, Singapore	
Meiling Address Block 212, #11-126	
Chua Chu Kang Central	
Singapore 680212	
SINGAPORE	
Full name of second inventor, if any	•
Weiping Deng	
Second inventor's signature	Date
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will righter	17 / 33
Residence	O
Shanghai, Chiza	
Citizenship People's Republic of China	
Mailing Address	
Apt #75, Rm 34	
Dongan Erchun	
Zhongshan Road No 2 (South)	
Shanghai 200032; PEOPLE'S REPUBLIC OF CHINA	
this is the form	
Full name of third inventor, if any	
Kanda Sangthongpitag Third inventor's signature	Date
.Tung machine a signame	
Residence	
Singapore, Singapore	
Citizenship Thailand	
Mailing Address	
30 Dover Rise, Dover Parkview	
Tower D. #16-03	
Singapore 138686	
SINGAPORE	
Full name of fourth inventor, if any	
Hong Y. Song	Date
Fourth inventor's signature	
Duidmas	·
Residence Singapore, Singapore	
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Citizenship People's Republic of China	
Malling Address	
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Singapore 120706 SINGAPORE	
DINORI ORD	**

Full name of fifth inventor, if any	
Eric T. Sun	Dete
Fifth inventor's signature	
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Citizenship US	
Mailing Address	
40 Coronation Road West	
#04-04 Astrid Meadows	
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SINOA! CICE	
Full name of sixth inventor, if any	
Niefang Yu	
Sixth inventor's signature	Date
	1
Residence	
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Citizanship People's Republic of China	
Mailing Address	
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Singapore 730410	
SINGAPORE	
Full name of seventh inventor, if any	<del></del>
Yong Zou	Date
Seventh inventor's signature	Data
Residence	
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Citizenship People's Republic of China	
Mailing Address	
Room 1804, Building 5	
No. 28 North Xizhimen Street	
Reijing 100088	
PEOPLE'S REPUBLIC OF CHINA	
Full name of eighth inventor, if any	
	Date
Eighth inventor's signature	
Residence	<del></del>
Cltizenship	
Mailing Address	

#### JUL. 13. 2006 4:10PM

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

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		ς.

Page 1 of 5

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## EARLIEST FOREIGN APPLICATION(S), IF ANY FILED WITHIN 12 MONTHS (6 MONTHS FOR DESIGN) PRIOR TO THIS U.S. APPLICATION

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I hereby appoint:

All practitioners at Customer Number 30678

all of Connolly Bove Lodge & Hutz LLP, 1990 M Street, N.W., Suite 800, Washington, DC 20036, jointly, and each of them severally, my attorneys at law/patent agent(s), with full power of substitution, delegation and revocation, to prosecute this application, to make alterations and amendments therein, to receive the patent, and to transact all business in the U. S. Patent and Trademark Office connected therewith.

The undersigned hereby authorizes the U.S. attorney or agent named herein to accept and follow instructions from S\*BIO Pte Ltd. as to any action to be taken in the United States Patent and Trademark Office regarding this application without direct communication between the U.S. attorney or agent and the undersigned. In the event of a change in the persons from whom instructions may be taken, the U.S. attorney or agent named herein will be so notified by the undersigned.

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